

XC8102 Series

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ETR2502-006a

Load Switch with Low On-Resistance

GENERAL DESCRIPTION

The XC8102 series is a low ON resistance load switch IC with ON/OFF control and output current protection which integrates a P-channel MOSFET.

By connecting the XC8102 to the output pin of a step-down DC/DC converter, the CE pin controls ON/OFF for each distribution switch to deliver power per requirements and maximize total power efficiency. As a result, the XC8102 helps to extend battery life and product operation time.

The series contains a current limit and protection circuit so these are not required externally unlike discrete circuit solutions where MOSFETs and resistors are used.

When a low signal is input to the CE pin, the series enters stand-by mode. Even where a load capacitor is connected to the output pin during stand-by, the electric charge stored at the load capacitor is discharged through the internal switch. As a result, the V_{OUT} pin voltage falls quickly to the V_{SS} level.

The series contains over current protection with fold-back current circuitry which operates as over current protection and short circuit protection for the output pin.

APPLICATIONS

Mobile phones, Smart phones

Digital still cameras, Digital video cameras

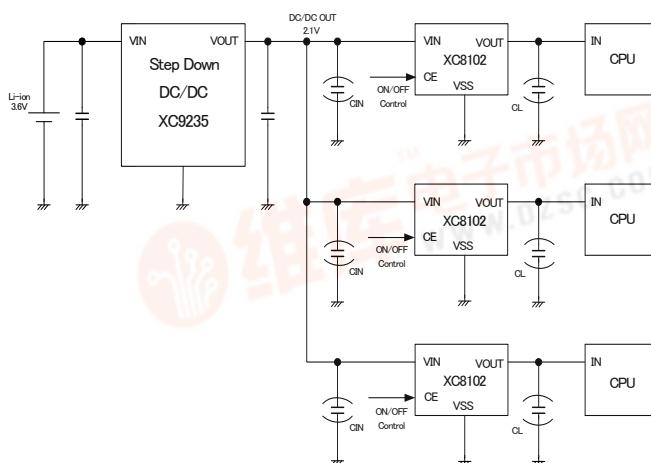
Portable game consoles

Portable equipment

FEATURES

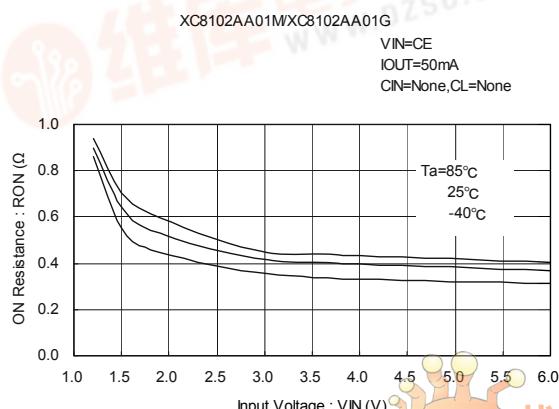
On Resistance	: 0.28Ω@ V _{IN} =6.0V (TYP.) : 0.31Ω@ V _{IN} =4.0V (TYP.) : 0.35Ω@ V _{IN} =2.9V (TYP.) : 0.52Ω@ V _{IN} =1.8V (TYP.) : 0.60Ω@ V _{IN} =1.5V (TYP.) : 0.80Ω@ V _{IN} =1.2V (TYP.) : 1.2V ~ 6.0V
Input Voltage Range	: 3.0 μA@ V _{IN} =1.2V : 3.6 μA@ V _{IN} =2.9V : 4.0 μA@ V _{IN} =6.0V
Power Consumption	
Stand-by Current	: 0.1 μA
Protection Circuit	: Current limit(Output Current) 480mA (TYP.) (1.8 VIN 6.0V) : Short-circuit Protection, Short current= 30mA (TYP.)
ON/OFF Function	: High Active Enable
High-Speed Discharge Function	
Operating Temperature Range	: -40 ~ +85
Packages	: USP-4,SSOT-24, SOT-25 USPN-4
Environmentally Friendly	: EU RoHS Compliant, Pb Free

TYPICAL APPLICATION CIRCUIT



TYPICAL PERFORMANCE CHARACTERISTICS

On Resistance vs. Input Voltage



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PIN CONFIGURATION

*The heat dissipation pad of the USP-4 package is recommended to solder as shown in the recommended mount pattern and metal mask pattern for mounting strength. The heat dissipation pad should be electrically opened or connected to the V_{ss}

PIN ASSIGNMENT

PIN NUMBER				PIN NAME	FUNCTIONS
USP-4	SOT-25	SSOT-24	USPN-4		
4	1	4	4	V _{IN}	Power Input
1	5	3	1	V _{OUT}	Output
2	2	2	2	V _{ss}	Ground
3	3	1	3	CE	ON/OFF Control
-	4	-	-	NC	No Connection

PRODUCT CLASSIFICATION

Ordering Information

XC8102 - (*¹)

DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTION
	CE pin logic	A	CE High active
	C _L Discharge Function	A	Output capacitor (C _L) auto-discharge function integrated
	Internal Standard Number	01	Fixed
-	Packages Taping Type (* ²)	GR-G	USP-4
		MR-G	SOT-25
		NR-G	SSOT-24
		7R-G	USPN-4

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SERIES	CE	IC OPERATIONAL STATUS ON/OFF
XC8102AA01	High	ON
	Low	OFF

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V_{IN}	$V_{SS}-0.3 \sim +6.5$	V
Output Current	I_{OUT}	850*	mA
Output Voltage	V_{OUT}	$V_{SS}-0.3 \sim V_{IN}$	V
CE Input Voltage	V_{CE}	$V_{SS}-0.3 \sim +6.5$	V
Power Dissipation	USP-4	120	mW
	SSOT-24	150	
	SOT-25	250	
	USPN-4	100	
Operating Temperature Range	T_{opr}	-40 ~ +85	°C
Storage Temperature Range	T_{stg}	□ +85	

* Please make sure that I_{OUT} is less than $P_d / (V_{IN} - V_{OUT})$

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ELECTRICAL CHARACTERISTICS

XC8102AA Series

T_a=25

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Input Voltage	V _{IN}		1.2	-	6.0	V	-
On Resistance (SSOT-24/USPN-4)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.28	0.425	Ω	①
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.31	0.475		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.35	0.475		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	0.52	0.625		
		V _{IN} =1.5V, V _{CE} =V _{IN}	-	0.60	0.80		
		V _{IN} =1.2V, V _{CE} =V _{IN}	-	0.80	1.60		
On Resistance (SOT-25/USP-4)	R _{ON}	V _{IN} =6.0V, V _{CE} =V _{IN}	-	0.35	0.475	Ω	②
		V _{IN} =4.0V, V _{CE} =V _{IN}	-	0.38	0.525		
		V _{IN} =2.9V, V _{CE} =V _{IN}	-	0.43	0.525		
		V _{IN} =1.8V, V _{CE} =V _{IN}	-	0.59	0.675		
		V _{IN} =1.5V, V _{CE} =V _{IN}	-	0.67	0.85		
		V _{IN} =1.2V, V _{CE} =V _{IN}	-	0.87	1.65		
Supply Current	I _{DD}	V _{IN} =6.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	4.0	7.0	μA	②
		V _{IN} =4.0V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.8	6.5		
		V _{IN} =2.9V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.6	6.3		
		V _{IN} =1.8V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.4	5.7		
		V _{IN} =1.5V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.2	5.5		
		V _{IN} =1.2V, V _{CE} =V _{IN} , V _{OUT} =OPEN	-	3.0	4.9		
Stand-by Current	I _{STBY}	V _{IN} =6.0V, V _{CE} =V _{SS} , V _{OUT} =OPEN	-	0.01	0.10	μA	②
Switch Leakage Current	I _{LEAK}	V _{IN} =6.0V, V _{CE} =V _{SS} , V _{OUT} =0V	-	0.01	0.10	μA	②
Current Limit	I _{LIM}	V _{IN} ≥2.9V, V _{OUT} =V _{IN} -0.8V	400	480	-	mA	①
		1.8V≤V _{IN} <2.9V, V _{OUT} =V _{IN} -0.6V	400	480	-		
		1.5V≤V _{IN} <1.8V, V _{OUT} =1.2V	200	-	-		
		1.2V≤V _{IN} <1.5V, V _{OUT} =1.0V	90	-	-		
Short Circuit Current	I _{SHORT}	V _{CE} =V _{IN} , V _{OUT} =0V	-	30	75	mA	①
CE High Level Voltage	V _{CEH}		1.1	-	6.0	V	③
CE Low Level Voltage	V _{CEL}		-	-	0.3	V	③
CE High Level Current	I _{CEH}	V _{CE} =V _{IN}	-0.1	-	0.1	μA	③
CE Low Level Current	I _{CEL}	V _{CE} =V _{SS}	-0.1	-	0.1	μA	③
C _L Auto-Discharge Resistance	R _{DCHG}	V _{IN} =4.0V, V _{OUT} =4.0V, V _{CE} =V _{SS}	380	480	570	Ω	④
Turn On Time ^(*)	t _{DLY(ON)}	V _{IN} =4.0V, V _{CE} =0.3V→1.2V, R _L =80Ω, without C _{IN} , C _L	-	8.5	18	μs	⑤
Turn Off Time ^(*)	t _{DLY(OFF)}	V _{IN} =4.0V, V _{CE} =1.2V→0.3V, R _L =80Ω, without C _{IN} , C _L	-	3.0	7.5	μs	⑤

NOTE:

*1: Time to reach 90% of V_{OUT} after V_{CE} entering the V_{CEH} threshold.

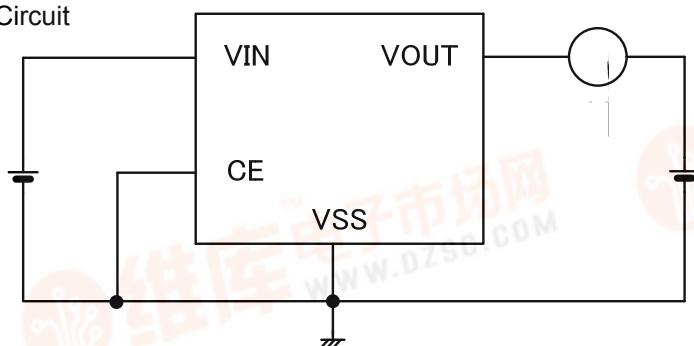
*2: Time to fall to 10% of V_{OUT} after V_{CE} entering the V_{CEL} threshold.

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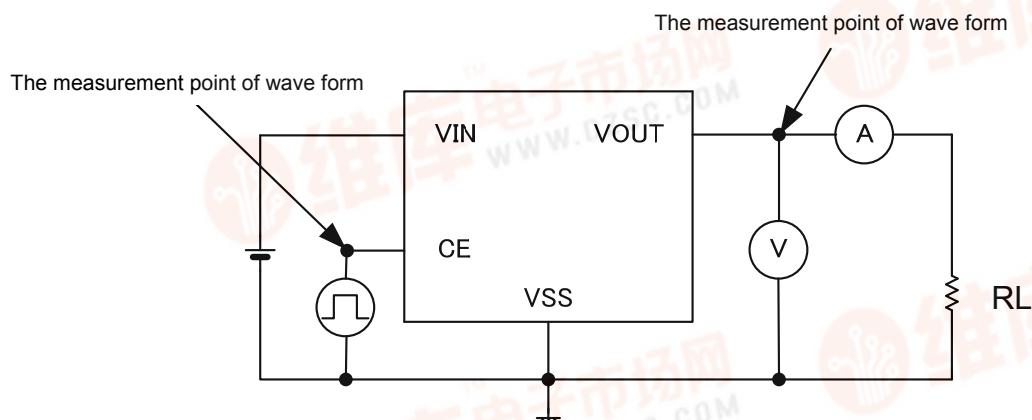


TEST CIRCUITS (Continued)

Circuit



Circuit



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OPERATIONAL EXPLANATION

<CE Pin>

The XC8102 enables an output P-channel MOSFET switch and the IC internal circuitry to turn off by the signal to the CE pin. In the shutdown mode, the V_{OUT} pin will be pulled down to the V_{SS} by the C_L auto-discharge function.

The output voltage becomes unstable when the CE pin is opened. If the input voltage to the CE pin is within the specified threshold voltages, the logic is fixed and the XC8102 will operate normally. However, supply current may increase as a result of the shoot-through current of internal circuitry when the medium level voltage is input to the CE pin.

<Input/Output Capacitor>

The XC8102 works well without an input and output capacitors. Also, an output capacitor of the power source can be used as an input capacitor of the XC8102 and a bypass capacitor of the driving IC can be used as an output capacitor of the XC8102.

<CL Auto-Discharge Function>

The XC8102AA contains a C_L auto-discharge resistor and an N-channel transistor between the V_{OUT} pin and the V_{SS} pin. The device quickly discharge the electric charge in the output capacitor (C_L) when a low signal to the CE pin is input to turn off a whole IC circuit. The C_L auto-discharge resistance is set at 480Ω (V_{OUT}=4.0V TYP. @ V_{IN}=4.0). Discharge time of the output capacitor (C_L) is determined by a CL auto-discharge resistor value (Rdischg) and an output capacitor value. Time constant τ is defined as ($\tau = C \times Rdischg$). Output voltage after starting discharge can be calculated by the following formula.

$$V = V_{OUT} \times e^{-t/\tau}, \text{ or } t = \ln(V_{OUT} / V) \times \tau$$

V: Output voltage after starting discharge,

V_{OUT}: Output voltage,

t : Discharge time,

: Output discharge resistor value Rdischg × Output capacitor (C_L) value C

<Current Limiter, Short-Circuit Protection>

The XC8102 series contains a constant current limiter and fold-back current circuitry. The constant current limiter operates to limit output current and the fold-back current circuitry operates as short circuit protection for the output pin.

When the load current reaches the limit current, the constant current limiter operates and the output voltage drops. The output voltage further, then the fold-back current circuitry operates to decrease the output current. When the output pin is short-circuited to the ground, the output current drops and maintains a flow about 30mA.

NOTES ON USE

1. Please use this IC within the stated absolute maximum ratings. Operation beyond these limits may cause degrading or permanent damage to the device.
2. The X8102 goes into an undefined operation when the CE pin is left open. The CE pin shall be tied to low or high level.
3. V_{OUT} pin voltage should not be applied beyond the V_{IN} pin voltage.
The IC may get damage due to the reverse current toward the V_{IN} pin.
4. Current limit function is integrated. However, power dissipation may be beyond the limit before starting a fold-back current protection when used in high temperature. For the power dissipation of each package, please refer to the graphs of Package Power vs. Operating Temperature in page 15 to 18.

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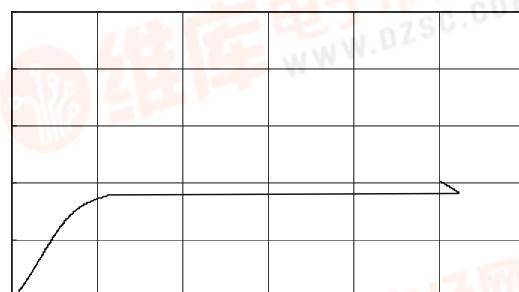
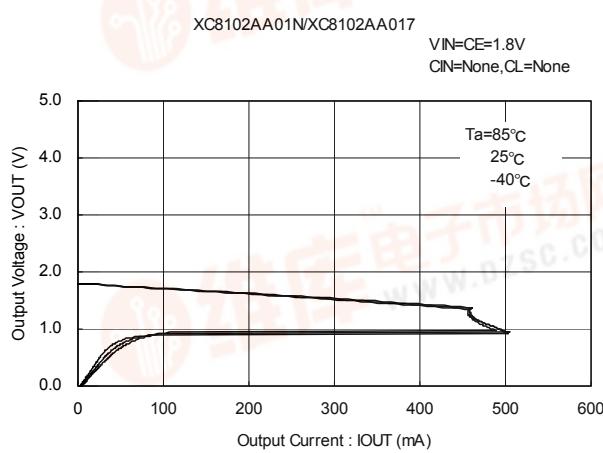
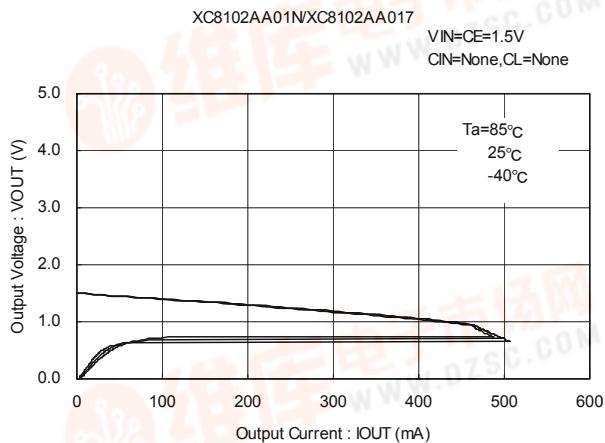
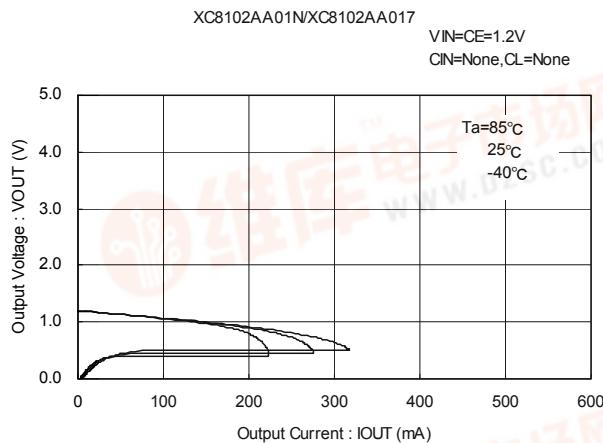
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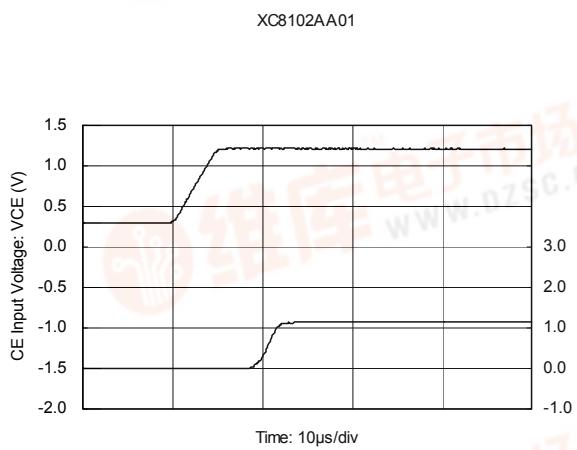
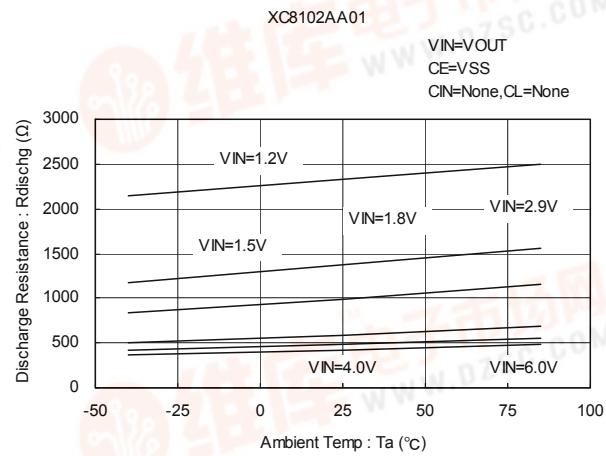
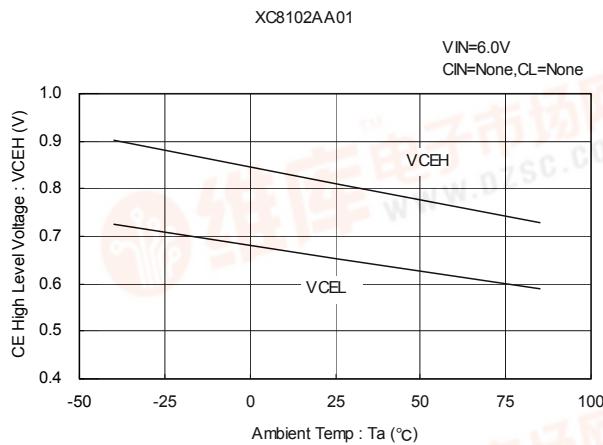


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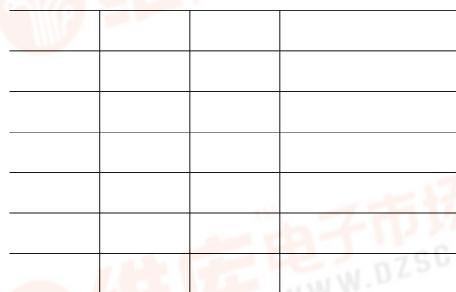
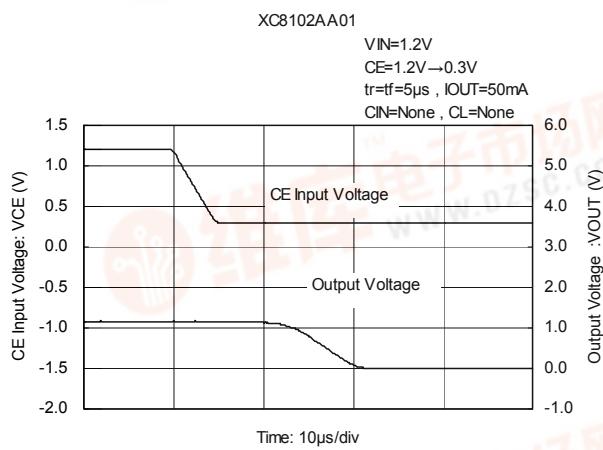
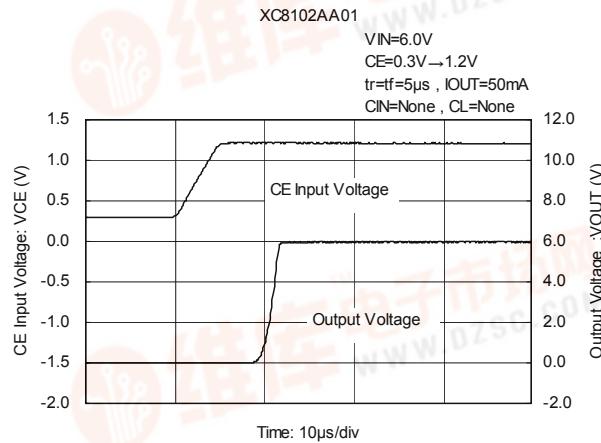
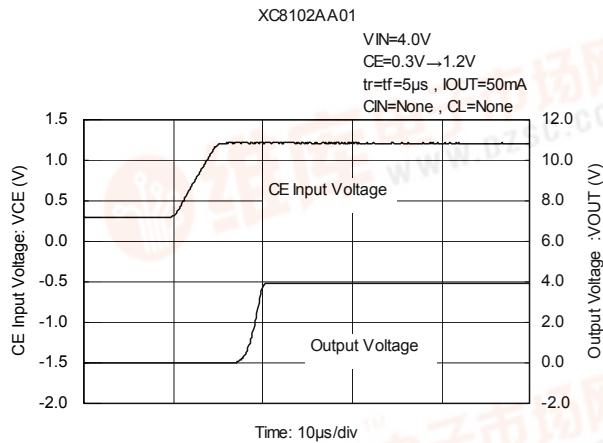


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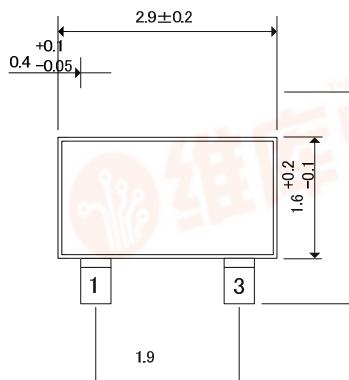
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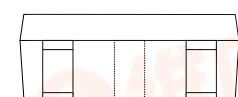
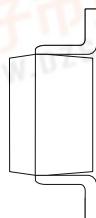
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PACKAGING INFORMATION

SOT-25



SSOT-24



USP-4

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PACKAGING INFORMATION (Continued)

SSOT-24 Power Dissipation

Power dissipation data for the SSOT-24 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

2. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

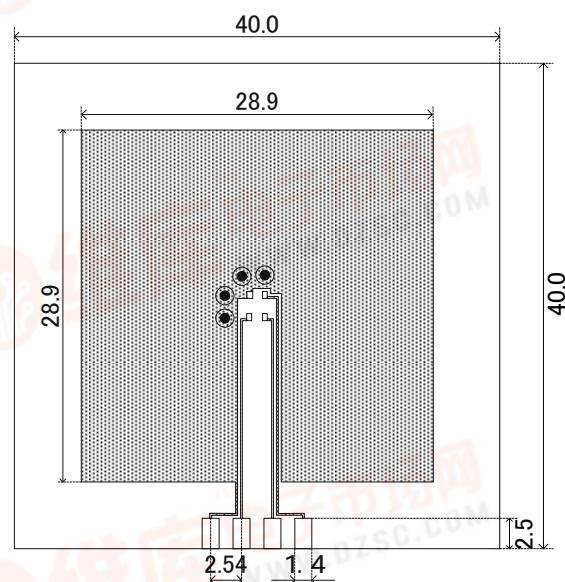
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter

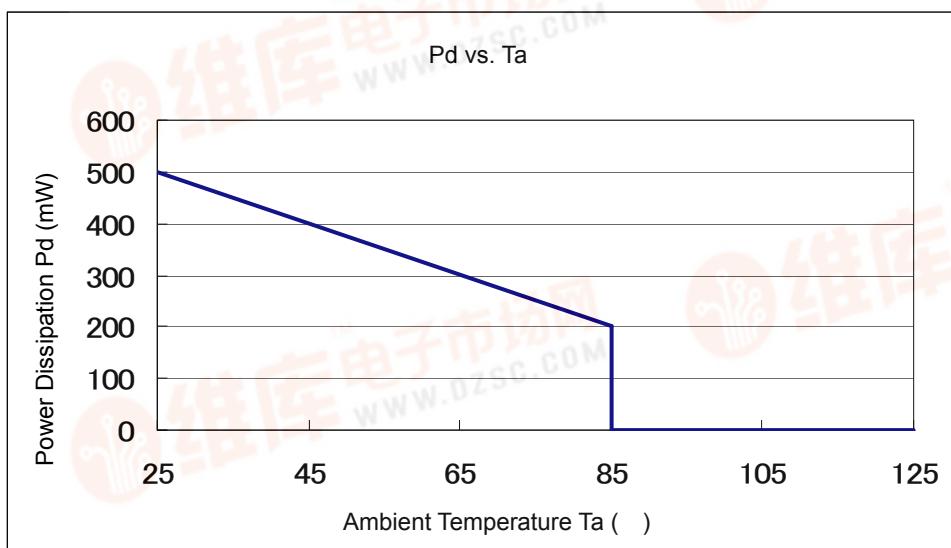


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125 °C)

Ambient Temperature (°C)	Power Dissipation P_d (mW)	Thermal Resistance (°C/W)
25	500	200.00
85	200	



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PACKAGING INFORMATION (Continued)

USPN-4 Power Dissipation

Power dissipation data for the USPN-4 is shown in this page.

The value of power dissipation varies with the mount board conditions.

Please use this data as one of reference data taken in the described condition.

2. Measurement Condition (Reference data)

Condition: Mount on a board

Ambient: Natural convection

Soldering: Lead (Pb) free

Board: Dimensions 40 x 40 mm (1600 mm² in one side)

Copper (Cu) traces occupy 50% of the board area

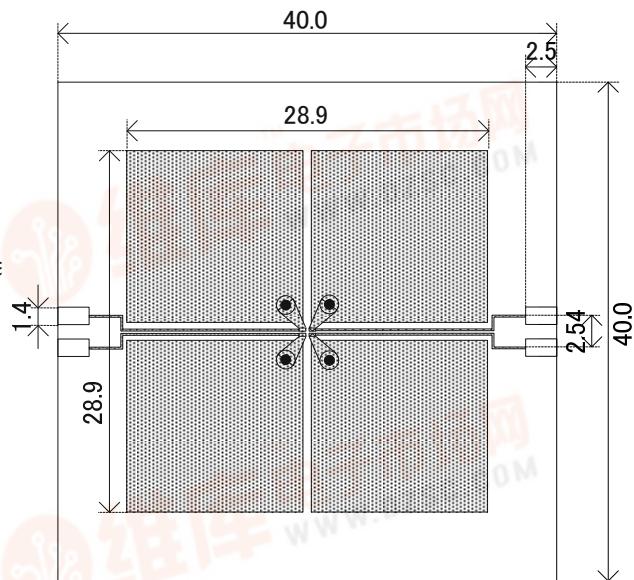
In top and back faces

Package heat-sink is tied to the copper traces

Material: Glass Epoxy (FR-4)

Thickness: 1.6 mm

Through-hole: 4 x 0.8 Diameter



Evaluation Board (Unit: mm)

2. Power Dissipation vs. Ambient Temperature

Board Mount (T_j max = 125 °C)

Ambient Temperature (°C)	Power Dissipation Pd(mW)	Thermal Resistance (°C/W)
25	640	166.67
85	240	

Pd-Ta特性グラフ



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